Ball / Land Grid Array Sockets





Interconnect

E-tec is now the leading BGA socket manufacturer.

EP patents 0829188, 0897655 US patents 6190181, 6249440 Patented in other countries.

Economy ClamShell sockets are available for any chip size and grid pattern. The SMT socket is simply placed and reflowed onto the PCB in the same way as the chip and occupies only a small amount of additional board space. The solderless sockets are mounted with 2 or 4 mounting pegs to the PCB depending on the chip size. The retainer uses a thumbscrew for applying the pressdown forces which does not require any tools for opening/closing of the socket. Stopper screws for setting of the pressdown forces are incorporated in this locking system and the retainer is "open top" for improved heat dissipation.

We aim to solve your requirements - many different terminals and configurations are available. Your custom sets our standards!



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